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Jimmy HDLS

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Atty. Dkt. No. OP-092000289

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s) : Jack Wang et al.

Serial No. : 10/717,447

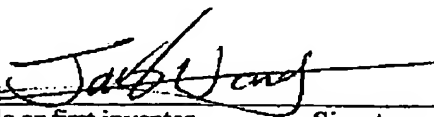
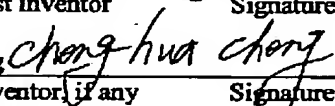

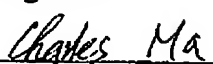
Filed : 11/21/2003

Group Art Unit: 3753

For : Heat Dissipating Device
Having Improved Fastening
StructureExaminer: Boris Leo
ChervinskyCHANGE OF
CORRESPONDENCE ADDRESSCommissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Please change the Correspondence Address for the above-identified patent
application to the address associated with Customer Number 46103

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